

TOSHIBA Diode Silicon Epitaxial Planar Type

1SS362FV

Ultra-High-Speed Switching Applications

- AEC-Q101 qualified (Note 1)
- Small package
- Excellent in forward current and forward voltage characteristics: $V_F(3) = 0.97\text{ V (typ.)}$
- Fast reverse recovery time: $t_{rr} = 1.6\text{ ns (typ.)}$
- Small total capacitance: $C_T = 0.9\text{ pF (typ.)}$

Note1: For detail information, please contact our sales.

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V_{RM}	85	V
Reverse voltage	V_R	80	V
Maximum (peak) forward current	I_{FM}	300 *	mA
Average forward current	I_O	100 *	mA
Surge current (10 ms)	I_{FSM}	1 *	A
Power dissipation	P	150 **	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 to 150	$^\circ\text{C}$

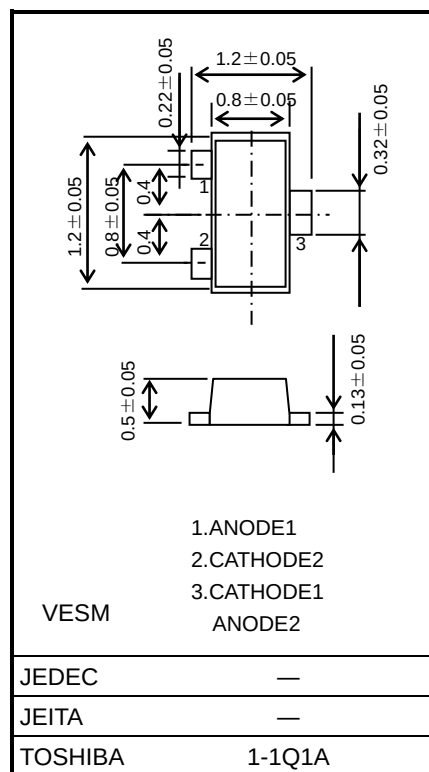
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

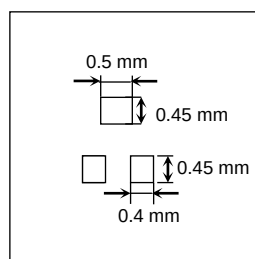
*: Unit rating. Total rating = unit rating $\times$ 0.7

**: Mounted on an FR4 board (25.4 mm $\times$ 25.4 mm $\times$ 1.6 mm (t))

Unit: mm



Weight: 1.5 mg (typ.)

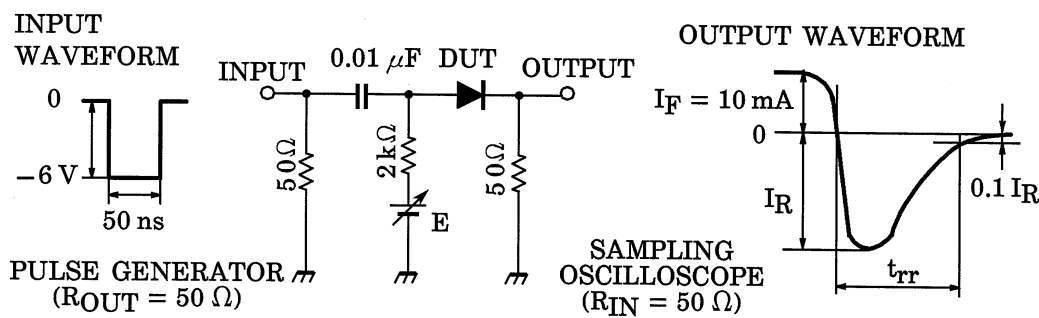


Start of commercial production
2004-09

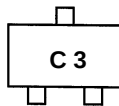
Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Forward voltage	V _F (1)	—	I _F = 1 mA	—	0.63	—	V
	V _F (2)	—	I _F = 10 mA	—	0.75	—	
	V _F (3)	—	I _F = 100 mA	—	0.97	1.20	
Reverse current	I _R (1)	—	V _R = 30 V	—	—	0.1	μA
	I _R (2)	—	V _R = 80 V	—	—	0.5	
Total capacitance	C _T	—	V _R = 0 V, f = 1 MHz	—	0.9	—	pF
Reverse recovery time	t _{rr}	—	I _F = 10 mA (Fig. 1)	—	1.6	4.0	ns

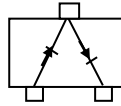
Fig. 1 Reverse Recovery Time (t_{rr}) Test Circuit

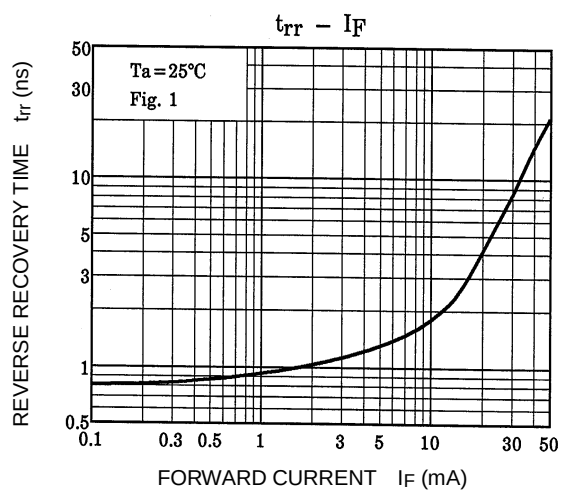
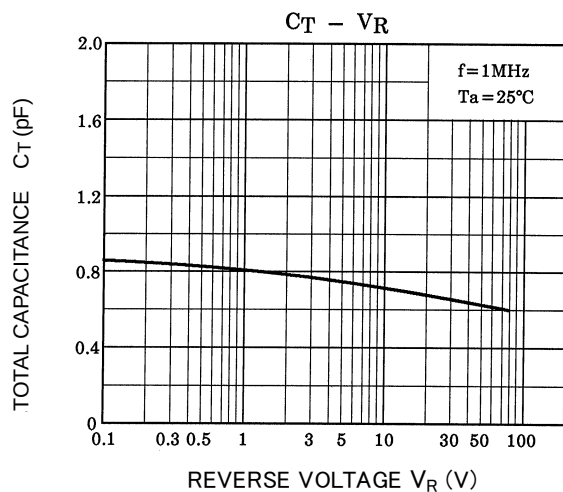
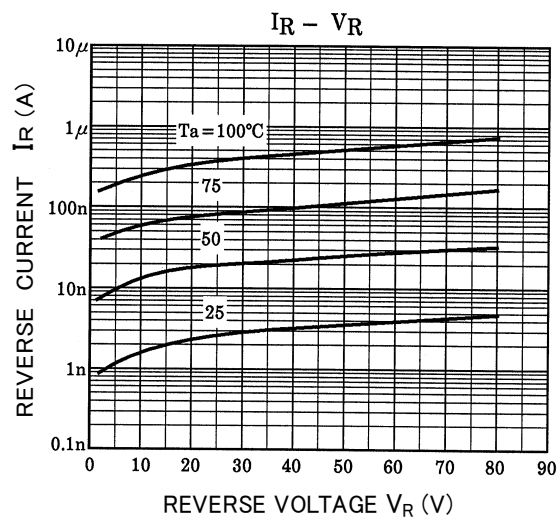
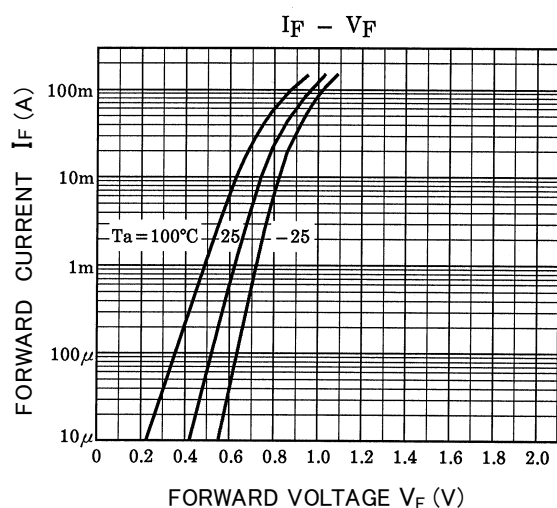


Marking



Equivalent Circuit (Top View)





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